

## **Instant Quote**

After receiving your quotation request, we promise to reply with our quotation including pricing and lead times within 24 working hours.

## **Delivery Lead Time**

Prototype: 7 days

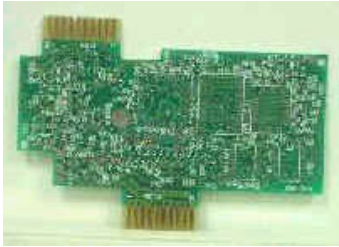
Production: 2 - 4 weeks

## **Technical Support**

Our engineers work closely with customers' design, technical and production engineers to develop a product satisfy your needs.

## **Assembly Service**

Partnering with local component assembly companies, we also provide assembled PCBs upon customer's request



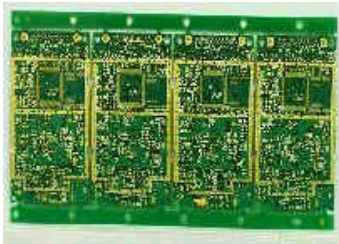
Board Type: Double-sided  
 Board Thickness:1.6mm  
 Copper Thickness:35um                      Solder Mask  
 Smallest Hole Size:0.6mm  
 Min.Track/spacing: 0.2/0.17mm  
 Gold connectors: 40                      Chamfer applied  
 Nickel:5um,Gold:2.5um  
 SMD: 2-sided                      Routing applied

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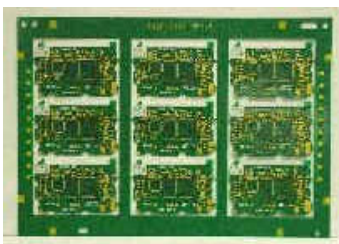
Board Type: 4 Layer  
 Board Thickness: 1.57mm  
 Copper Thickness:70um                      Solder Mask  
 Smallest Hole Size: 0.356mm  
 Min.Track/spacing: 0.2/0.2mm  
 Gold connections: 96  
 Nickel: 3.81-7.62um,Gold:2.5um  
 Scoring applied

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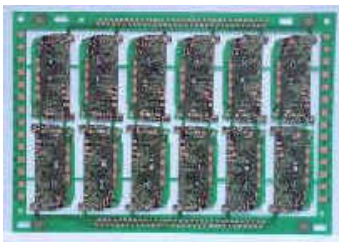
Board Type: 4 Layer  
 Board Thickness: 1.6mm  
 Copper Thickness:35um                      Solder mask  
 Smallest Hole Size:0.2mm (via hole)  
 Min.Track/spacing: 0.17/0.152mm  
 ENIG:Ni:3-5um,Au:0.05-0.10um  
 SMD:2-sided  
 Routing applied

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Board Type:4 Layer  
 Board Thickness:0.8mm  
 Copper Thickness:35um                      Solder Mask  
 Smallest Hole Size:0.4mm  
 Min.Track/spacing:0.15/0.15mm  
 ENIG and Selective Gold Plating applied  
 Nickel:3-6um,Gold: 1um

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Board Type:4 layer  
 Board Thickness: 0.8mm  
 Copper Thickness:18um                      Solder Mask  
 Smallest Hole size:0.3mm  
 Min.Track/spacing:0.15/0.15mm  
 Entek: 0.3-0.4um  
 Guaranteed Storage Period:6 months  
 Punching applied

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